# DETECTOR AND ELECTRONICS INTEGRATION FOR THE CGEM **INNER TRACKER**

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Institute of High Energy Physics
Chinese Academy of Sciences

On behalf of the CGEM-IT working group



Design

Readout chain

Control & Monitor
Integration test
Resultspreliminary

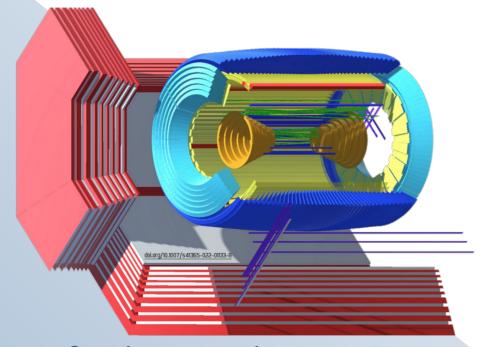
OUTLINE

### @BEPCII

e<sup>+</sup>e<sup>-</sup> collider τ-charm factory

 $E_{cm} = 2 - 4.95 \text{ GeV}$ 

 $L = 10^{33} / cm^2 s$ 





**MDC** 0.5% at 1 GeV/c

CsI(Tl) calorimeter 2.5% @ 1 GeV

**BTOF** 70 ps

ETOF 60 ps

**dE/dx** 6% e<sup>-</sup> from Bhabha scattering

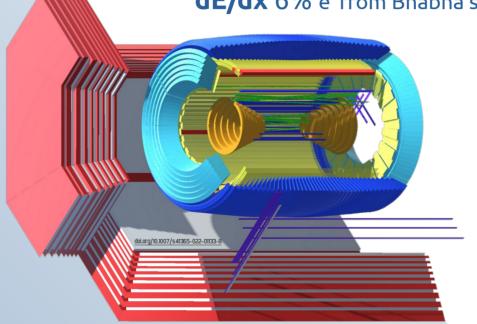
@BEPCII

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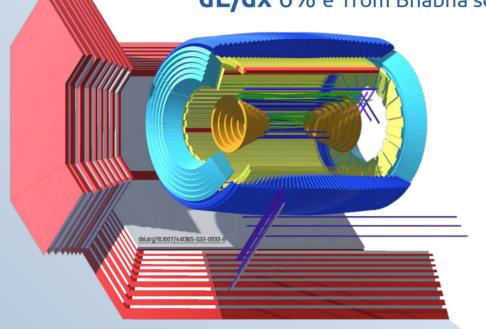
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 $e^+e^-$  collider  $\tau$ -charm factory  $E_{cm} = 2 - 4.95$  GeV  $L = 10^{33}$  /cm<sup>2</sup>s

@BEPCII



We have collected

10B of J/ψ!

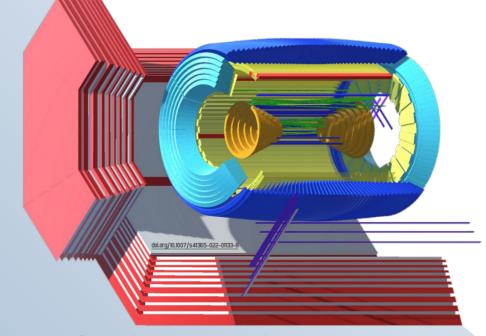
The world largest data sample

**BESIII** 

Extension of the data taking for other

10 years!

iopscience.iop.org/article/10.1088/1674-1137/44/4/040001



BESIII

# MULTI LAYER DRIFT CHAMBER

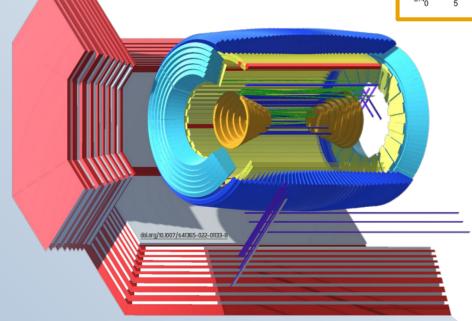
INNER LAYERS
Gain loss / year ~4%

0.9 0.9 0.9 0.0

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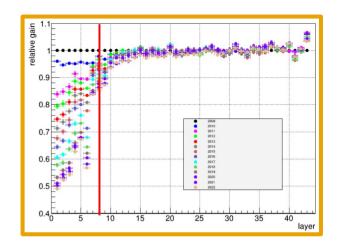
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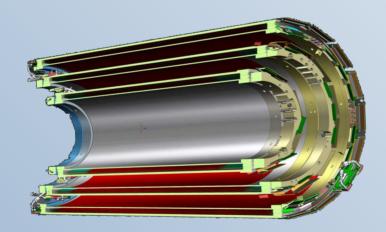


to be installed in 2024



High Rate
High Radiation Hardness
93% Solid Angle Coverage
Low Material Budget <1.5% X

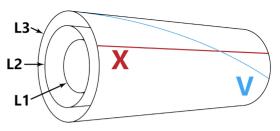
Triple GEM
Inner Tracker

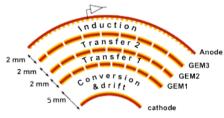


DESIGN

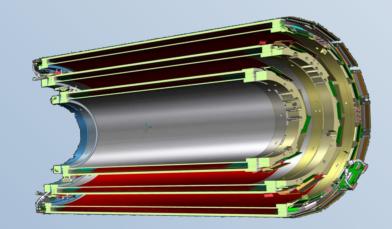
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Triple GEM

High Rate





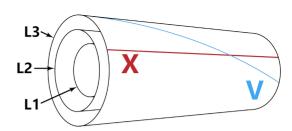
Triple GEM
X-V Anode Segmentation
Time and Charge Analogue Readout

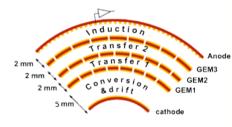


Inner Tracker

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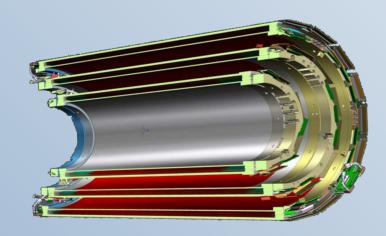




Triple GEM

X-V Anode Segmentation

Time and Charge Analogue Readout



Inner Tracker

High Gain

Low discharge Probability
Improved spatial resolution

 $\sigma_z \sim 350 \mu m$ 

 $\sigma_{xy} \sim 130$ mm

 $\sigma_{pt}$  ~0.5% @1 GeV/c

**DESIGN** 

Contiguous strips fired on the anode form a cluster

To optimize the recontruction at different angles in 1T magnetic field,

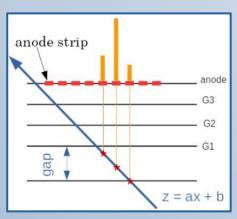
a merge of two algorithm is used

# SOFTWARE

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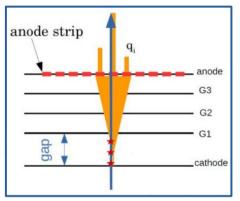


μ-TPC

$$x_{\mu TPC} = \frac{gap/2 - b}{a}$$



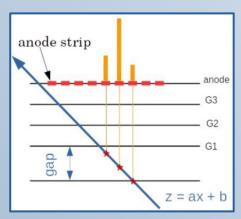
$$x_{\text{CC}} = \frac{\sum_{i}^{N_{\text{hit}}} Q_{\text{hit},i} x_{\text{hit},i}}{\sum_{i}^{N_{\text{hit}}} Q_{\text{hit},i}}$$



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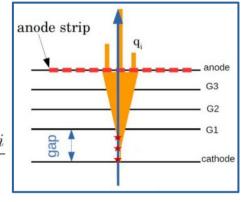


#### μ-TPC

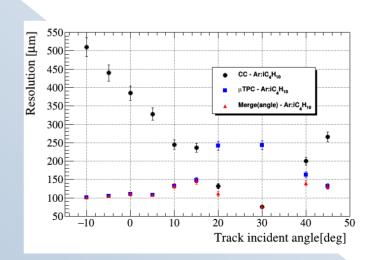
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# CHARGE CENTROID

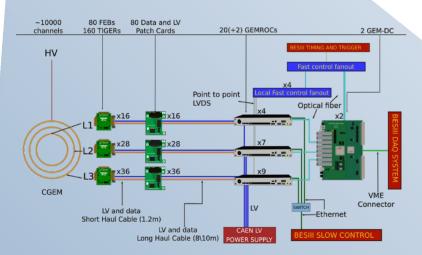
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# SOFTWARE



Inspirehep.net/literature/1750024 10.1088/1748-0221/14/08/P08018

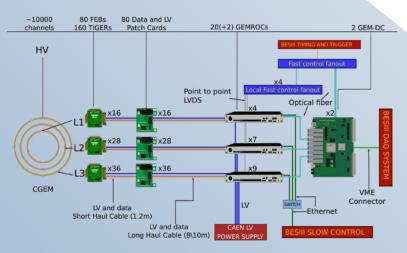




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#### **TIGER**

64-channels ASIC
Charge & Time readout
Sample&Hold
Time Over Threshold



Parameters	Value
Input Charge	2-50 fC
Input Capacitance	Up to 100 pF
Data Rate	60 kHz/ch
Readout Mode	Trigger-less
Non-linearity	<1%
Charge Collection Time	60 ns
Time resolution	<5 ns
<b>Power Consumption</b>	<12 mW/ch
Technology	110 nm process

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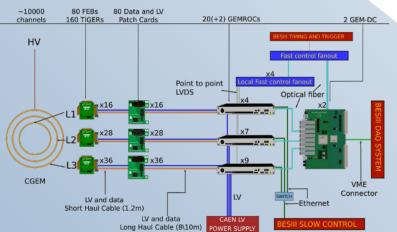
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Power the FEB
Configure the chips

Receive timing signals

Monitor chips voltages and temperature

Control data acquisition via optical links/Ethernet



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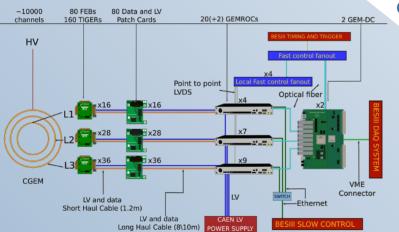
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#### TIMING SIGNALS

Fast Control System Fanout

Fast Control System Local Fanout to receive and distribute
BESIII clock and trigger to each GEMROC

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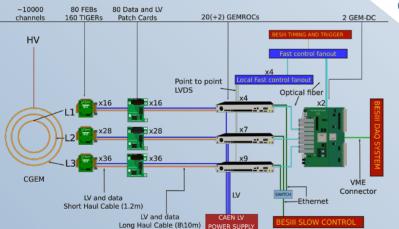
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#### TIMING SIGNALS

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Data Rate

Readout Mode

Non-linearity

Charge Collection Time

Time resolution

Power Consumption

Technology

Fast Control System Fanout

Fast Control System Local Fanout to receive and distribute
BESIII clock and trigger to each GEMROC

#### **USER INTERFACE**

Value

2-50 fC

Up to 100 pF

60 kHz/ch Trigger-less

<1%

60 ns

<5 ns

<12 mW/ch

110 nm process

Graphical User Frontend Interface (GUFI)

Python based software

Test, characterize and debug the system

## @Beijing

Temporary cosmic stand

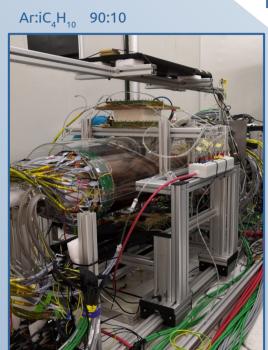
Two (out of three) CGEM layers

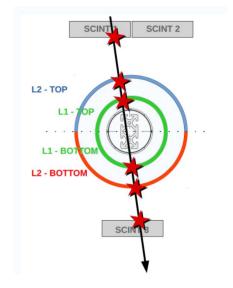
~5.6k channels connected

Final LV and HV systems

Remote control

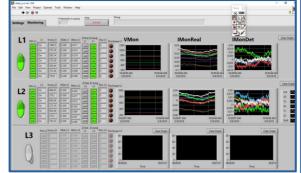
On-site maintenance



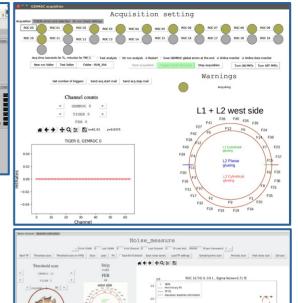


## DATA TAKING since 2019

# HV & LV Custom Controls



Power on/off
Current absorption
DAQ operations
Noise tests

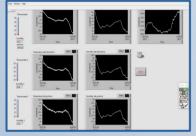


To test the system for commissioning

# **CONTROL & MONITOR**

# HV & LV Custom Controls

### **Environment Parameters**



To guarantee the detector safety



Gas flux

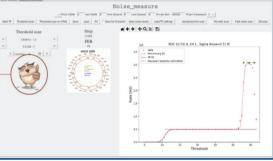
Cooling flux and pressure

Temperature, Humidity and Pressure



Power on/off
Current absorption
DAQ operations
Noise tests





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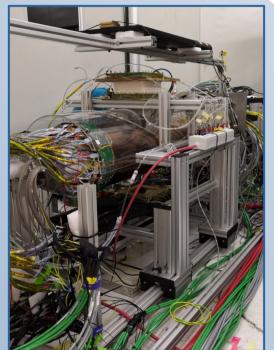
### **CONTROL & MONITOR**

## @Beijing

Temporary cosmic stand

Two (out of three) CGEM layers

Ar:iC<sub>4</sub>H<sub>10</sub> 90:10



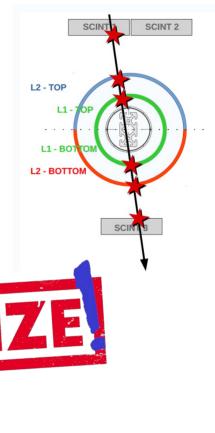
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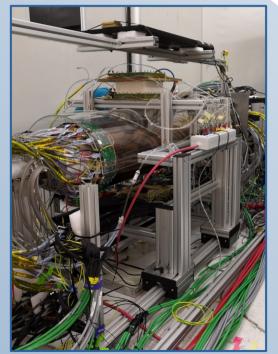
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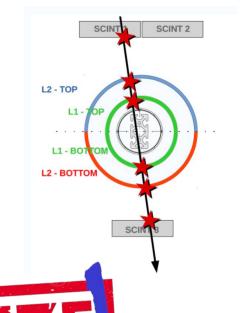


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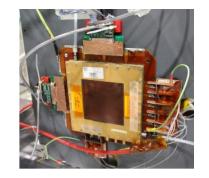


Thorough operations' monitoring



## DATA TAKING since 2019

#### Local setup to overcome the impossibility to travel to China



@CERN SPS H4 80 GeV muon beam



Telescope for cosmic in Ferrara

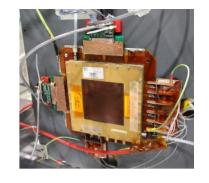
Telescope for test beam in H4 line at CERN





INTEGRATION<sup>2</sup> Since 2020

#### Local setup to overcome the impossibility to travel to China



@CERN SPS H4 80 GeV muon beam



Telescope for cosmic in Ferrara

Telescope for test beam in H4 line at CERN

Four planar triple-GEMs

Tilting mechanics (x-view)

Simpler HV system

@FERRARA (IT)



Benchmark with APV/SRS electronics

Tests with TIGER/GEMROC on-going

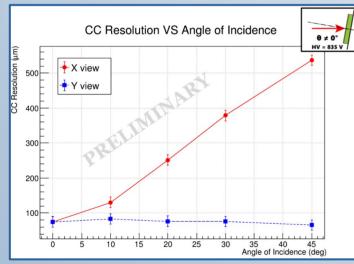
Fanout modules

Online and offline analysis

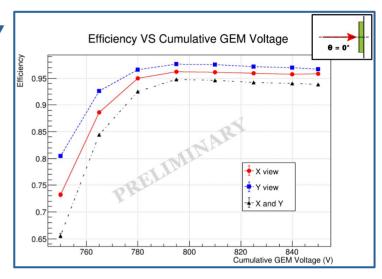
INTEGRATION<sup>2</sup> Since 2020

#### **EFFICIENCY**

At  $\theta$  = 0° about 60 µm  $\mu$ -TPC analysis in progress to improve resolution at large angles



**CHARGE CENTROID** 



Grounding scheme and data buffering improvements are being upgraded to try to solve this efficiency losses

### RESULTS

### The commissioning of the CGEM-IT started...

The pandemic slowed down the operation

Two layers are taking data remotely since 2020

The detectors safety were guaranteed by a thorough monitoring

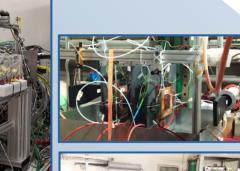
The third layer is under construction

A simpler/narrower setup have been implemented

The development of the integration is on-going

The preliminary results are promising

@Beijing @Italy @CERN









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